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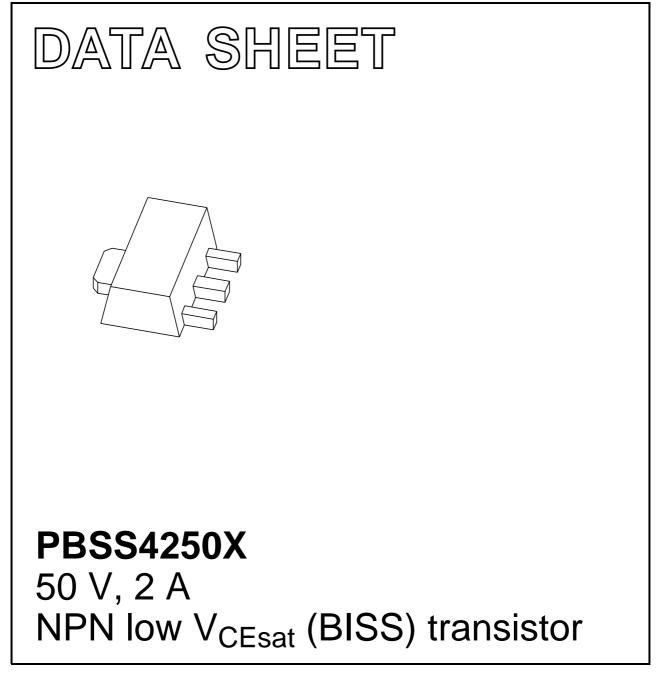
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Team Nexperia

DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 2003 Jun 17 2004 Nov 08



50 V, 2 A NPN low V_{CEsat} (BISS) transistor

FEATURES

- SOT89 (SC-62) package
- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability: I_C and I_{CM}
- Higher efficiency leading to less heat generation
- Reduced printed-circuit board requirements.

APPLICATIONS

- Power management
 - DC/DC converters
 - Supply line switching
 - Battery charger
 - LCD backlighting.
- Peripheral drivers
 - Driver in low supply voltage applications (e.g. lamps and LEDs).
 - Inductive load driver (e.g. relays, buzzers and motors).

DESCRIPTION

NPN low V_{CEsat} transistor in a SOT89 plastic package. PNP complement: PBSS5250X.

MARKING

| TYPE NUMBER | MARKING CODE ⁽¹⁾ | | |
|-------------|-----------------------------|--|--|
| PBSS5250X | *1M | | |

Note

- 1. * = p: Made in Hong Kong
 - * = t: Made in Malaysia
 - * = W: Made in China.

ORDERING INFORMATION

| TYPE NUMBER | PACKAGE | | | |
|-------------|------------------|--|---------|--|
| ITPE NUMBER | NAME DESCRIPTION | | VERSION | |
| PBSS4250X | SC-62 | SC-62 plastic surface mounted package; collector pad for good heat transfer; 3 leads | | |

QUICK REFERENCE DATA

| r | | 1 | |
|--------------------|------------------------------|------|------|
| SYMBOL | PARAMETER | MAX. | UNIT |
| V _{CEO} | collector-emitter voltage | 50 | V |
| I _C | collector current (DC) | 2 | А |
| I _{CM} | peak collector current | 5 | А |
| R _{CEsat} | equivalent on-resistance 160 | | mΩ |

PINNING

| PIN | DESCRIPTION | |
|-----|-------------|--|
| 1 | emitter | |
| 2 | collector | |
| 3 | base | |

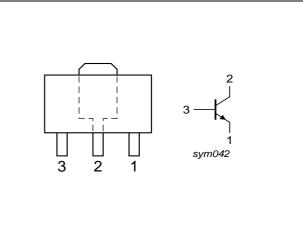


Fig.1 Simplified outline (SOT89) and symbol.

PBSS4250X

PBSS4250X

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|---------------------------|--------------------------------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | — | 50 | V |
| V _{CEO} | collector-emitter voltage | open base | — | 50 | V |
| V _{EBO} | emitter-base voltage | open collector | — | 5 | V |
| I _C | collector current (DC) | | — | 2 | A |
| I _{CM} | peak collector current | limited by T _{j(max)} | - | 5 | А |
| I _B | base current (DC) | | — | 0.5 | А |
| P _{tot} | total power dissipation | $T_{amb} \le 25 \ ^{\circ}C$ | | | |
| | | note 1 | — | 550 | mW |
| | | note 2 | — | 1 | W |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | - | 150 | °C |
| T _{amb} | ambient temperature | | -65 | +150 | °C |

Notes

- 1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.
- 2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm².

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|----------------------|---|-------------|-------|------|
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | | |
| | | note 1 | 225 | K/W |
| | | note 2 | 125 | K/W |
| | | note 3 | 90 | K/W |
| | | note 4 | 80 | K/W |
| R _{th(j-s)} | thermal resistance from junction to soldering point | | 16 | K/W |

Notes

1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.

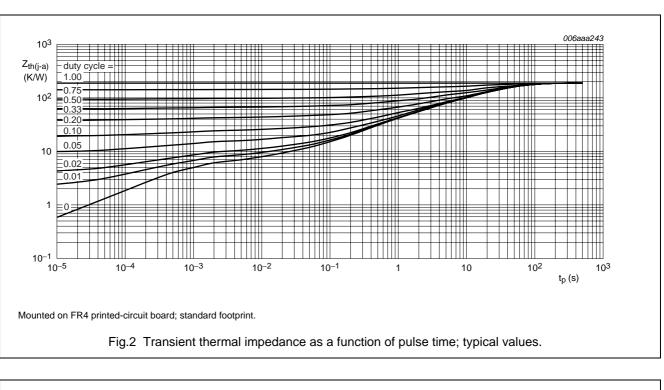
2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm².

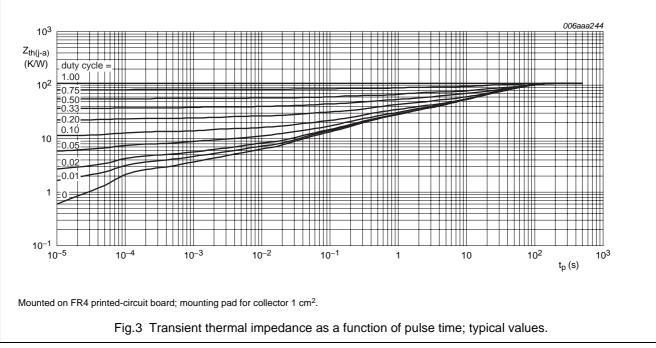
3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm².

4. Device mounted on a ceramic printed-circuit board 7 cm², single-sided copper, tin-plated.

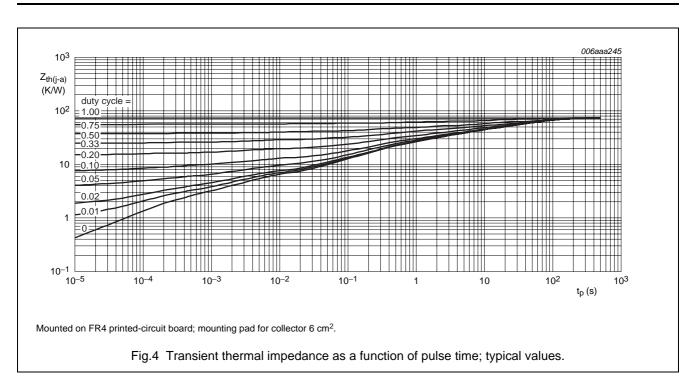
50 V, 2 A NPN low V_{CEsat} (BISS) transistor

PBSS4250X





PBSS4250X



PBSS4250X

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

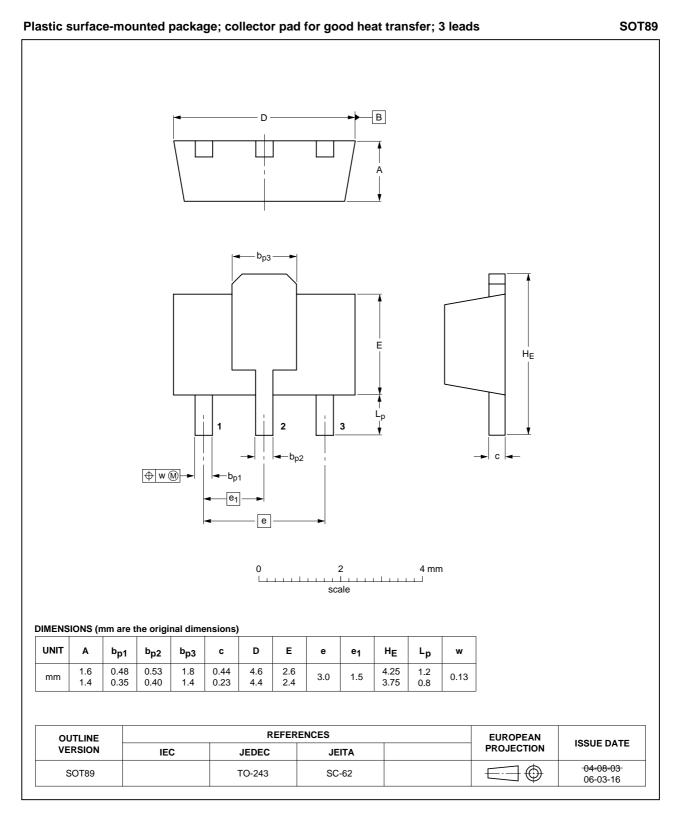
| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|--------------------|-----------------------------------|--|------|------|------|
| I _{CBO} | collector-base cut-off current | V _{CB} = 50 V; I _E = 0 A | - | 100 | nA |
| | | V _{CB} = 50 V; I _E = 0 A; T _j = 150 °C | _ | 50 | μA |
| I _{CES} | collector-emitter cut-off current | V _{CE} = 50 V; V _{BE} = 0 V | - | 100 | nA |
| I _{EBO} | emitter-base cut-off current | V _{EB} = 5 V; I _C = 0 A | - | 100 | nA |
| h _{FE} | DC current gain | $V_{CE} = 2 V$ | | | |
| | | I _C = 0.1 A | 300 | - | |
| | | I _C = 0.5 A | 300 | - | |
| | | I _C = 1 A; note 1 | 300 | - | |
| | | I _C = 2 A; note 1 | 150 | - | |
| V _{CEsat} | collector-emitter saturation | I _C = 0.5 A; I _B = 50 mA | - | 90 | mV |
| | voltage | I _C = 1 A; I _B = 50 mA | - | 250 | mV |
| | | I _C = 2 A; I _B = 100 mA | - | 380 | mV |
| | | I _C = 2 A; I _B = 200 mA; note 1 | - | 320 | mV |
| R _{CEsat} | equivalent on-resistance | I _C = 2 A; I _B = 200 mA; note 1 | - | 160 | mΩ |
| V _{BEsat} | base-emitter saturation voltage | I _C = 2 A; I _B = 100 mA | - | 1.1 | V |
| V _{BEon} | base-emitter turn-on voltage | V _{CE} = 2 V; I _C = 1 A | 1.1 | - | V |
| f _T | transition frequency | $I_{C} = 100 \text{ mA}; V_{CE} = 5 \text{ V}; f = 100 \text{ MHz}$ | 100 | - | MHz |
| C _c | collector capacitance | $V_{CB} = 10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A}; \text{ f} = 1 \text{ MHz}$ | - | 25 | pF |

Note

1. Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02.$

PBSS4250X

PACKAGE OUTLINE



50 V, 2 A NPN low V_{CEsat} (BISS) transistor

PBSS4250X

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|-----------------------------------|----------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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NXP Semiconductors

Customer notification

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Contact information

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